

Miniature Atomic Clock

MAC-SA5X



For applications requiring atomic clock stability performance that are unable to accommodate the size and power requirements of rack-mount equipment, the Miniaturized Rb Atomic Clock (MAC-SA5X) is a lowprofile, PCB-mountable oscillator. It provides users with a reliable and stable frequency source within minutes of power-on.

By leveraging Coherent Population Trapping (CPT) technology used in the Chip Scale Atomic Clock (CSAC) and the previous generation "MAC - SA.3Xm", the new MAC-SA5X family of clocks is the latest advancement in small atomic oscillators. CPT-based oscillators feature a laser to interrogate the Rb atoms and achieve atomic resonance. This allows a reduction in size and power compared to traditional lamp-based clocks, without compromising the performance one would expect from an atomic clock: fast retrace, resistance to static gforces, exceptional temperature stability, changes and low frequency drift rates.

MAC-SA5X shares the same footprint with the legacy SA.3Xm and many traditional OCXOs, but its performance versus size is unparalleled. Its hardware and software have been completely redesigned to add new features such as 1PPS synchronization, improve stability, and operate over a wide temperature range of thermal environments. This combination of features, along with the ability to quickly provide an atomic frequency reference, is particularly powerful for mobile applications where every minute and every Watt counts.

KEY FEATURES

- Sub-microsecond holdover for 48 hour missions*
- Drift rate $<5 \times 10^{-11}$ Hz/Hz /mo (SA55)
- Operating Temperature -40°C to $+75^{\circ}\text{C}$
- Temperature-induced frequency errors $<5 \times 10^{-11}$ Hz/Hz from -10°C to $+75^{\circ}\text{C}$
- Backwards compatible pin-out/footprint of legacy MACSA.3Xm oscillator
- Rapid, reliable warm-up time <8 minutes
- 1PPS output and input for easy calibration/synchronization
- New software allows greater control and health monitoring
- Lead free: RoHS compliant
- Small size: $2 \times 2 \times 0.7$ inches

*Predicted assuming zero initial phase/frequency offset, static environment, 25°C , on for 30 days prior to holdover.

KEY APPLICATIONS

- Stand-alone (free-run) stable frequency source for audio equipment, LTE base stations, smart grid and enterprise network infrastructure
- Extended holdover for base stations
- Portable test equipment
- Autonomous sensor networks

Specifications @ 5V & 25°C (ambient), unless noted otherwise

Electrical

RF Output (Pin 3)			
Frequency	10 MHz		
Format CMOS	(0 to 3.3V)		
Load Impedance	1 MΩ		
Rise/Fall time	< 4 ns		
Duty Cycle	50% ±10%		
Quantity	1		
1PPS Output (Pins J1-17, 19)			
Format	LVDS Square Wave		
Level	EIA/TIA-644 compliant		
Rise/Fall time	< 4 ns		
Pulse Width (Programmable)	20 μs (100 nS – 100 mS, 10 nS step)		
Quantity	1		
1PPS Input (Pins J1-5,7 or J1-1,3)			
Format	LVDS Rising Edge		
Level	EIA/TIA-644 compliant		
Quantity	2		
Minimum Pulse Width	100 ns		
Serial Communication (Pins 7,8)			
Protocol	Rs232 UART		
Format	CMOS (0 to 3.3V)		
Tx/Rx Impedance	1 MΩ		
BAUD rate	57600		
High Speed Communication (Pins J1-2,4,6)			
Protocol	USB 2.0 compatible		
Built In Test Equipment (BITE) Output (Pin 6)			
Format	CMOS (0 to 3.3V)		
Load Impedance	1 MΩ		
Logic	Low = Normal Operation High = No Physics Lock		
Alarm Output (Pin J1-20)			
Format	CMOS (0 to 3.3V)		
Load Impedance	1 MΩ		
Logic	Low = Normal Operation, High = Alarm		
Power Input (Pin 5)			
Voltage Range	4.5 to 32V DC		
Power Consumption			
	Typical (W)	Max (W)	
Operating Temperature**	65°C:	4.0	6
	25°C:	6.3	8
	-10°C:	8.3	11
	-40°C:	10.0	14
Warmup	@All Temps:	14	

**Ambient temperature. Thermal environment will affect exact power consumption/TempCo. Contact factory for details. DO NOT EXCEED 75°C MEASURED AT BASEPLATE.

Performance Parameters	
Time to Lock	< 8m (> -10°C) < 12m (< -10°C)
Analog Tuning Range	> ±1 × 10 ⁻⁸ Hz/Hz (Resolution: 1 × 10 ⁻¹¹ Hz/Hz) (0 to 5V into 5 kΩ)
Digital Tuning Range	±1 × 10 ⁻⁶ Hz/Hz (Resolution: 1 × 10 ⁻¹⁵ Hz/Hz)
Frequency Offset	< ±5 × 10 ⁻¹¹ Hz/Hz (at shipment)
Retrace	< ±5 × 10 ⁻¹¹ Hz/Hz (after 24h on, 48h off, 12h on)

Stability

ADEV	Sa55 (Hz/Hz)	Sa53 (Hz/Hz)
τ = 1 s	< 3 × 10 ⁻¹¹	< 5 × 10 ⁻¹¹
τ = 10 s	< 1 × 10 ⁻¹¹	< 1.6 × 10 ⁻¹¹
τ = 100 s	< 3 × 10 ⁻¹²	< 5 × 10 ⁻¹²
τ = 1,000 s	< 1 × 10 ⁻¹²	
τ = 10,000 s	< 3 × 10 ⁻¹²	
Frequency Drift	Sa55 (Hz/Hz)	Sa53 (Hz/Hz)
Monthly***	< 5 × 10 ⁻¹¹	< 1 × 10 ⁻¹⁰
Yearly	< 6 × 10 ⁻¹⁰	< 1.5 × 10 ⁻⁹
Daily***	< 2.5 × 10 ⁻¹¹	< 2.5 × 10 ⁻¹¹
*** After 1 month and 1 day of continuous operation, respectively		
Phase Noise (SSB)	Sa55 (dBc/Hz)	Sa53 (dBc/Hz)
1 Hz	< -70	< -65
10 Hz	< -87	< -85
100 Hz	< -114	< -112
1 kHz	< -130	< -130
10 kHz	< -140	< -140
Spurious (nonharmonic)	< -85 dBc	
TempCo (Peak-to-Peak)	Sa55 (Hz/Hz)	Sa53 (Hz/Hz)
-10 to +75°C (baseplate)	≤ 5 × 10 ⁻¹¹	≤ 1 × 10 ⁻¹⁰
40 to +75°C**	≤ 1 × 10 ⁻¹⁰	≤ 5 × 10 ⁻¹⁰

Environmental

Operating		
Temperature Range	-40°C to +75°C**	
Magnetic Sensitivity (frequency change)	< 2 Gauss ($\pm 7 \times 10^{-11}$ Hz/Hz /Gauss)	
Voltage Sensitivity (frequency change)	± 1 V DC ($< 1 \times 10^{-11}$ Hz/Hz, p-p)	
Vibration	7.7 grms/axis per MIL-STD-810, Fig 514.7E-1, Category 24 (General Minimum Integrity Exposure): no loss of lock.	
Shock	30g, 11 ms half-sine pulse per MIL-STD-202, Method 213, Test Condition J, 18 shocks (3+ & 3- per axis): no loss of lock, $\leq 4 \times 10^{-8}$ Hz/Hz frequency perturbation momentary	
Humidity	GR-63-CORE, issue 4, April 2012, section 4.1.2	
Altitude	50,000 feet	
Non-Operating (Storage & Transport)		
Temperature Range	-55°C to +100°C	
Vibration	10.9 Grms @ 1 hr/axis per MIL-STD-810, Fig 514.7E-1, Category 24 (General Minimum Integrity Exposure)	
Shock	50g, 11 ms half-sine pulse per MIL-STD-202, Method 213, Test Condition A, 18 shocks (3+ & 3- per axis)	
Altitude	70,000 feet	
Name	Part Number	Description
MAC-SA55	090-44550-01	5×10^{-11} /mo, 5×10^{-11} TempCo, AT disabled
MAC-SA53	090-44530-01	1×10^{-10} /mo, 1×10^{-10} TempCo, AT disabled Note: AT = Analog Tuning
MAC-SA5X Kit	090-44500-000	Developers Kit. Does not include MAC

Mechanical

Size	2 x 2 x 0.7 in
Weight	< 100 g (3.5 oz)
MTBF	149,743 h (Ground Benign, per MIL-HDBK-217F, 40°C baseplate)
RoHS	2011/65/EU

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Baseplate Connector	
Pin	Function
1	Analog Tuning
2	Case Ground
3	RF Output
4	GND (Signal & Supply)
5	Input Supply (4.5 to 32V)
6	BITE
7	RS-232 Tx
8	RS-232 Rx
J1 Connector	
Pin	Function
1	PPS-in 1+
3	PPS-in 1-
5	PPS-in 0+
7	PPS-in 0-
9	GND
11	NC
13	NC
15	GND
17	PPS-out +
19	PPS-out -
2	USB data +
4	USB data -
6	USB Power
8	GND
10	NC
12	NC
14	NC
16	NC
18	NC
20	ALARM